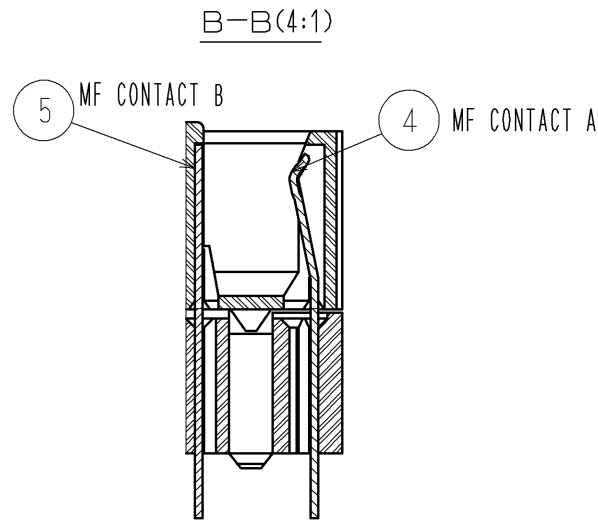
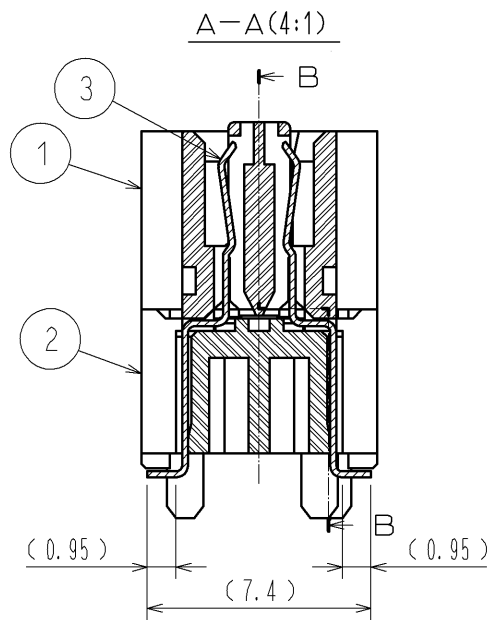
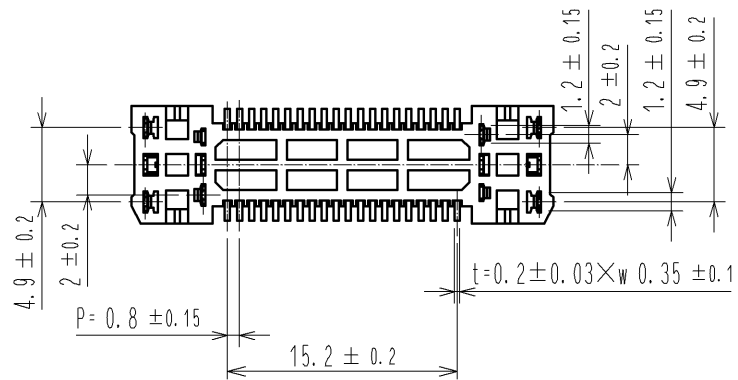
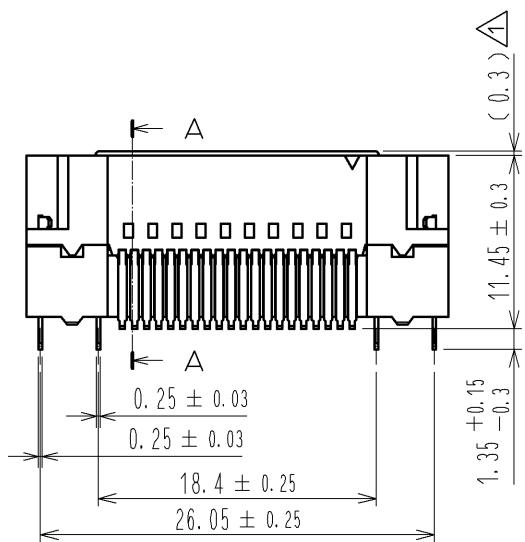
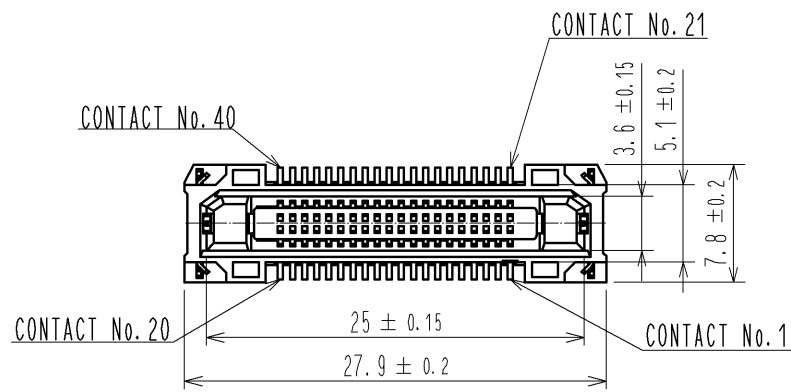
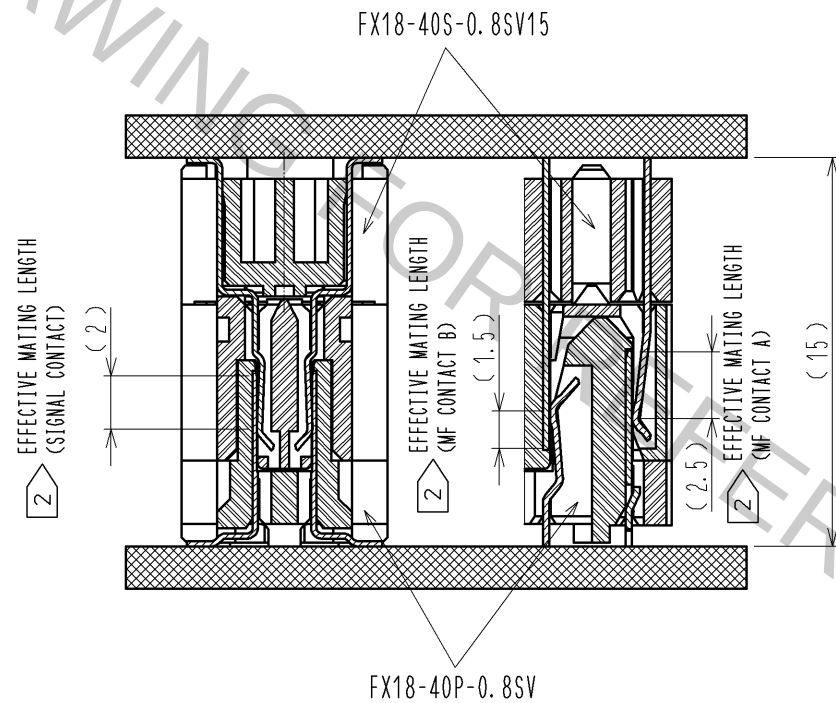
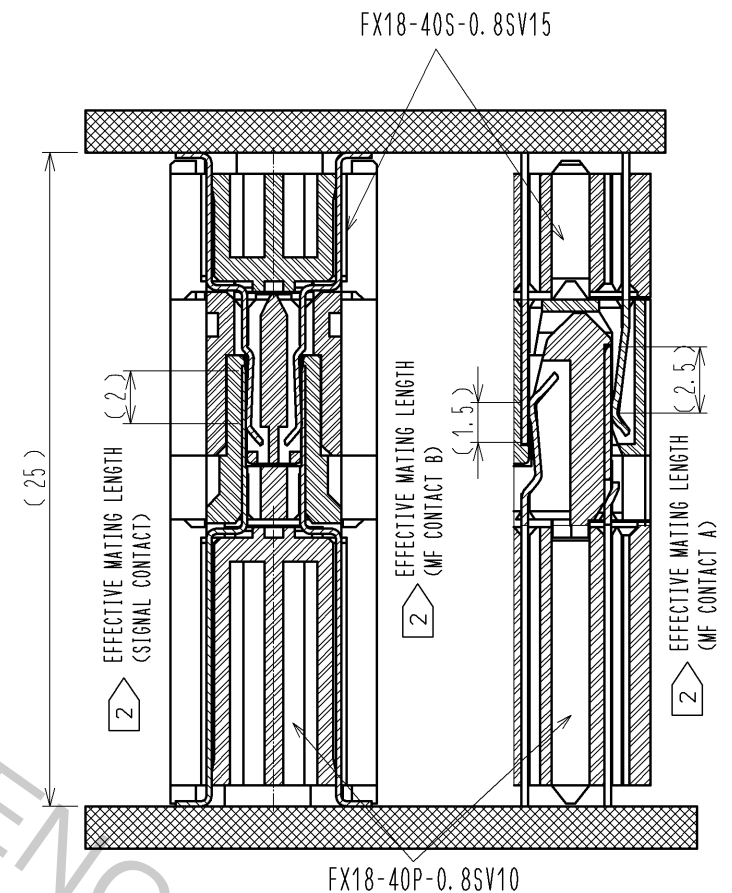




CROSS SECTION OF MATING(FREE)
STACKING HEIGHT=15mm



CROSS SECTION OF MATING(FREE)
STACKING HEIGHT=25mm



NOTE 1 LEAD CO-PLANARITY IS 0.1mm MAX.

2 CONTACTS ARE 3 STEPS SEQUENTIAL. (MF CONTACT A=>SIGNAL CONTACT=>MF CONTACT B)
WHEN USING THIS SEQUENTIAL STRUCTURE, PLEASE AVOID ANGLED INSERTION.

3 MF CONTACT A AND MF CONTACT B CAN BE USED AS POWER SUPPLY CONTACT. (3A/PIN MAX)

4 IT SHOWS THE VACUUM PICKUP AREA. (SEE PAGE 2)

REMOVE THE MYLAR TAPE BEFORE MATING CONNECTORS.

5 THIS IS PACKAGED IN TRAY. (60pcs/TRAY)

6 BLEMISH AND HIT MARK CAN BE OCCURED THROUGH OUT THE MANUFACTURING PROCESS WHICH DOESN' T AFFECT QUALITY LEVEL.

7 THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCES.

3	PHOSPHOR BRONZE	CONTACT AREA:GOLD 0.1 μm	5	COPPER ALLOY	CONTACT AREA:GOLD 0.1 μm
		LEAD AREA:GOLD 0.03 μm			LEAD AREA:TIN-PLATING 1 μm
		UNDER PLATING:NICKEL 1.3 μm			UNDER PLATING:NICKEL 1.3 μm
2	POLYAMIDE	BLACK UL94V-0	4	COPPER ALLOY	CONTACT AREA:GOLD 0.1 μm
1	POLYAMIDE	BLACK UL94V-0			LEAD AREA:TIN-PLATING 1 μm
					UNDER PLATING:NICKEL 1.3 μm
NO.	MATERIAL	FINISH , REMARKS	NO.	MATERIAL	FINISH , REMARKS
UNITS mm		SCALE 2 : 1	COUNT 4	DESCRIPTION OF REVISIONS DIS-F-005578	DESIGNED TH. SANO
		APPROVED : HS. OKAWA 11.03.18		DRAWING NO. EDC3-334386-00	
		CHECKED : KI. HIROKAWA 11.03.18		PART NO. FX18-40S-0.8SV15	
		DESIGNED : TH. SANO 11.03.18		CODE NO. CL579-0026-3-00	
		DRAWN : TH. SANO 11.03.18			
				1/2	
				11.07.21	
				KI. HIROKAWA	

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In case that the application demands a high level of reliability, such as automotive,
please contact a company representative for further information.

